## Report No.: NB2008031306-8-1

# **Test Report**

Testing institute	:	Ningbo Product Technology Service Co., Ltd. 3F, 601#,Mid JinShan Road, Yinzhou District, Ningbo 315192 P.R.China
Applicant	:	Yuyao Yunhuan Fanghua Electronics Co., Ltd. Simen Town, Yuyao, Zhejiang 315472 P.R. China
Test item(s)	:	PVC 粒子 / PVC Particle
Model/Type	:	/
Sample Description	:	White
Material	:	/
Sample receive date Completes date		Mar. 14,2008 Mar. 15,2008
Testing location	:	Ningbo Product Technology Service Co., Ltd.
Test specification(s)	:	EC Directive 2002/95/EC—The Restriction of the Use of Certain Hazardous Substances in Electrical and Electronic Equipment —— (RoHS)

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Page 2 of 4

				Page 2 of 4		
Test specification : EC Directive	2002/95/EC—The	Restriction of the	Use of Certain			
1	dous Substances in Electrical and Electronic Equipment— (RoHS)					
	54/CDV (Project Number: 62321, Ed.1) – Procedures for Determination					
	six Regulated Subst	. ,		clemination		
	•			Cond		
Requirement : EC Directive 2002/95/EC, 2005/618/EC, 2005/717/EC, 2005/747/EC, and 2006/310/EC						
Tested item: PVC 粒子 / PVC Particle		<u> </u>				
Parameter:	Unit	Result	Requirement	Conclusion		
Lead (Pb)	mg/kg	42	1000	Pass		
Cadmium (Cd)	mg/kg	<2	100	Pass		
Mercury (Hg)	mg/kg	<2	1000	Pass		
Chromium VI (Cr VI)	mg/kg	<2	1000	Pass		
Polybrominated Biphenyls (PBBs)	r	I	I	r		
1. Monobromobiphenyls	mg/kg	<5				
2. Dibromobiphenyls	mg/kg	<5				
3. Tribromobiphenyls	mg/kg	<5				
4. Tetrabromobiphenyls	mg/kg	<5				
5. Pentabromobiphenyls	mg/kg	<5				
6. Hexabromobiphenyls	mg/kg	<5				
7. Heptabromobiphenyls	mg/kg	<5				
8. Octabromobiphenyls	mg/kg	<5				
9. Nonabromobiphenyls	mg/kg	<5				
10.Decabromobiphenyl	mg/kg	<5				
Group PBBs	mg/kg		1000	Pass		
Polybrominated Diphenyl Ethers (PBD	Es)					
1. Monobromodiphenyl ethers	mg/kg	<5				
2. Dibromodiphenyl ethers	mg/kg	<5				
3. Tribromodiphenyl ethers	mg/kg	<5				
4. Tetrabromodiphenyl ethers	mg/kg	<5				
5. Pentabromodiphenyl ethers	mg/kg	<5				
6. Hexabromodiphenyl ethers	mg/kg	<5				
7. Heptabromodiphenyl ethers	mg/kg	<5				
8. Octabromodiphenyl ethers	mg/kg	<5				
9. Nonabromodiphenyl ethers	mg/kg	<5				
10. Decabromodiphenyl ether *	mg/kg	<5				
Group PBDEs	mg/kg					
Group PBDEs excluding Deca-BDE	mg/kg		1000	Pass		
*= Exemption item, see annex1		1	1			

Main test instruments used for this method:

Parameter	Method in IEC 111/54/CDV	Instrument	Manufactory	Model / Type
Pb & Cd	Chapter 11	ICP-OES	PerkinElmer	Optima 2100 DV
Hg	Chapter 10	ICP-OES	PerkinElmer	Optima 2100 DV
Cr VI	Chapter 9	UV	CANY	S22PC
PBBs &				
PBDEs	Chapter 7	GC-MS	Agilent Technologies	GC (6890)-MS (5975)

Sample photo(s), see annex2

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## ANNEX1

### Exemption items:

The below items are quoted according to 2002/95/EC, 2005/717/EC, 2005/747/EC, 2006/310/EC, 2006/690/EC, 2006/691/EC and 2006/692/FC

Applications of lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls (PBB) or polybrominated diphenyl ethers (PBDE) which are exempted from the requirements of Article 4(1)

- 1. Mercury in compact fluorescent lamps not exceeding 5 mg per lamp.
- 2. Mercury in straight fluorescent lamps for general purposes not exceeding: 10 mg
  - halophosphate - triphosphate with normal lifetime 5 mg - triphosphate with long lifetime 8 mg.
- 3. Mercury in straight fluorescent lamps for special purposes.
- 4. Mercury in other lamps not specifically mentioned in this Annex. 5. Lead in glass of cathode ray tubes, electronic components and fluorescent tubes.
- 6. Lead as an alloying element in steel containing up to 0,35 % lead by weight, aluminium containing up to 0,4 % lead by weight and as a copper alloy containing up to 4 % lead by weight.
- 7. Lead in high melting temperature type solders (i.e. lead-based alloys containing 85 % by weight or more lead), lead in solders for servers, storage and storage array systems, network infrastructure equipment for switching, signalling, transmission as well as network management for telecommunications. - lead in electronic ceramic parts (e.g. piezoelectronic devices).
- 8. Cadmium and its compounds in electrical contacts and cadmium plating except for applications banned under Directive 91/338/EEC (\*) amending Directive 76/769/EEC (\*\*) relating to restrictions on the marketing and use of certain dangerous substances and preparations.
- 9. Hexavalent chromium as an anti-corrosion of the carbon steel cooling system in absorption refrigerators.
- 9a. DecaBDE in polymeric applications
- 9b. Lead in lead-bronze bearing shells and bushes

10 -

- 11. Lead used in compliant pin connector systems.
- 12. Lead as a coating material for the thermal conduction module c-ring.
- 13. Lead and cadmium in optical and filter glass.
- 14. Lead in solders consisting of more than two elements for the connection between the pins and the package of microprocessors with a lead content of more than 80% and less than 85% by weight
- 15. Lead in solders to complete a viable electrical between semiconductor die and carrier within integrated circuit Flip Chip packages.
- 16. Lead in linear incandescent lamps with silicate coated tubes.
- 17. Lead halide as radiant agent in High Intensity Discharge (HID) lamps used for professional reprography applications
- 18. Lead as activator in the fluorescent powder (1 % lead by weight or less) of discharge lamps when used as sun tanning lamps containing phosphors such as BSP (BaSi2O5:Pb) as well as when used as speciality lamps for diazo-printing reprography, lithography, insect traps, photochemical and curing processes containing phosphors such as SMS ((Sr,Ba)2MgSi2O7:Pb).
- 19. Lead with PbBiSn-Hg and PbInSn-Hg in specific compositions as main amalgam and with PbSn-Hg as auxiliary amalgam in very compact Energy Saving Lamps (ESL). Lead oxide in glass used for bonding front and rear substrates of flat fluorescent lamps used for Liquid Crystal Displays (LCD).
- 20 Lead oxide in glass used for bonding front and rear substrates of flat fluorescent lamps used for Liquid Crystal Displays (LCD).
- 21. Lead and cadmium in printing inks for the application of enamels on borosilicate glass.
- 22. Lead as impurity in RIG (rare earth iron garnet) Faraday rotators used for fibre optic communications systems.
- 23. Lead in finishes of fine pitch components other than connectors with a pitch of 0.65 mm or less with NiFe lead frames and lead in finishes of fine pitch components other than connectors with a pitch of 0.65 mm or less with copper lead frames.
- 24. Lead in solders for the soldering to machined through hole discoidal and planar array ceramic multilayer capacitors.
- 25. Lead oxide in plasma display panels (PDP) and surface conduction electron emitter displays (SED) used in structural elements;
- notably in the front and rear glass dielectric layer, the bus electrode, the black stripe, the address electrode, the barrier ribs, the seal frit and frit ring as well as in print pastes.
- 26. Lead oxide in the glass envelope of Black Light Blue (BLB) lamps.
- 27. Lead alloys as solder for transducers used in high-powered (designated to operate for several hours at acoustic power levels of 125 dB SPL and above) loudspeakers.
- 28. Hexavalent chromium in corrosion preventive coatings of unpainted metal sheetings and fasteners used for corrosion protection and Electromagnetic Interference Shielding in equipment falling under category three of Directive 2002/96/EC (IT and telecommunications equipment). Exemption granted until 1 July 2007
- 29. Lead bound in crystal glass as defined in Annex I (Categories1, 2, 3 and 4) of Council Directive 69/493/EEC

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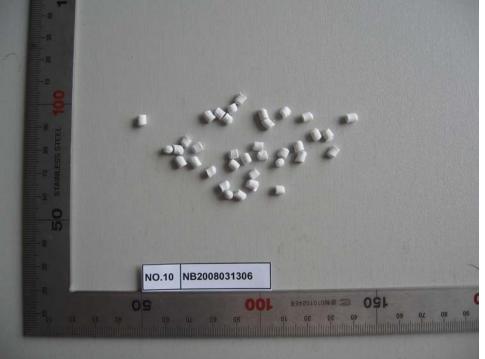
Page 3 of 4

Report No.: NB2008031306-8-1

## **ANNEX 2**

Sample photos, consists of 1 page





1: PVC 粒子 / PVC Particle

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